



Product Change Notification

Change Notification #: 117241 - 00
Change Title: Intel® Server Chassis H2312XXLR3, PCN 117241-00, Label, Intel® Server Chassis and Package Regulatory Label Update
Date of Publication: October 30, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	November 18, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel® is updating the Intel Server Chassis and Package Regulatory Label Removing Vietnam (ICT) Logo:

Common:

Package:



Customer Impact of Change and Recommended Action:

Intel® does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2312XXLR3	954487	J57869-006	J57869-007

PCN Revision History:

Date of Revision:

October 30, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmc.pcn@intel.com

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